

# SKM 800GA176D



**SEMITRANS® 4**

## Trench IGBT Modules

**SKM 800GA176D**

Preliminary Data

### Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CEsat}$  with positive temperature coefficient
- High short circuit capability, self limiting to  $6 \times I_C$

### Typical Applications

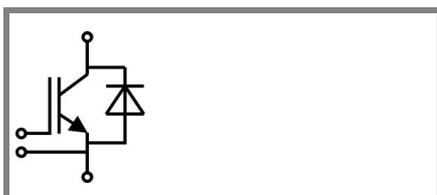
- AC inverter drives mains 575 - 750 V AC
- Public transport (auxiliary syst.)
- Wind power

### Remarks

- $I_{DC} \leq 500$  A limited for  $T_{Terminal} = 100$  °C

Absolute Maximum Ratings		$T_c = 25$ °C, unless otherwise specified	
Symbol	Conditions	Values	Units
<b>IGBT</b>			
$V_{CES}$	$T_j = 25$ °C	1700	V
$I_C$	$T_j = 150$ °C	$T_c = 25$ °C	830
		$T_c = 80$ °C	590
$I_{CRM}$	$I_{CRM} = 2 \times I_{Cnom}$	1200	A
$V_{GES}$		$\pm 20$	V
$t_{psc}$	$V_{CC} = 1200$ V; $V_{GE} \leq 20$ V; $T_j = 125$ °C $V_{CES} < 1700$ V	10	$\mu$ s
<b>Inverse Diode</b>			
$I_F$	$T_j = 150$ °C	$T_c = 25$ °C	630
		$T_c = 80$ °C	440
$I_{FRM}$	$I_{FRM} = 2 \times I_{Fnom}$	1200	A
$I_{FSM}$	$t_p = 10$ ms; sin.	$T_j = 150$ °C	3600
<b>Module</b>			
$I_{t(RMS)}$		500	A
$T_{vj}$		- 40 ... + 150	°C
$T_{stg}$		- 40 ... + 125	°C
$V_{isol}$	AC, 1 min.	4000	V

Characteristics		$T_c = 25$ °C, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
<b>IGBT</b>					
$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 24$ mA	5,2	5,8	6,4	V
$I_{CES}$	$V_{GE} = 0$ V, $V_{CE} = V_{CES}$		$T_j = 25$ °C $T_j = 125$ °C	0,2 0,6	mA
$V_{CE0}$			$T_j = 25$ °C	1	1,2
			$T_j = 125$ °C	0,9	1,1
$r_{CE}$	$V_{GE} = 15$ V		$T_j = 25$ °C	1,7	2,1
			$T_j = 125$ °C	2,5	
$V_{CE(sat)}$	$I_{Cnom} = 600$ A, $V_{GE} = 15$ V		$T_j = 25$ °C <sub>chiplev.</sub>	2	2,45
			$T_j = 125$ °C <sub>chiplev.</sub>	2,45	2,9
$C_{ies}$	$V_{CE} = 25$ , $V_{GE} = 0$ V	$f = 1$ MHz		39,6	nF
$C_{oes}$			2,2	nF	
$C_{res}$			2,5	nF	
$Q_G$	$V_{GE} = -8V...+15V$		4800		nC
$t_{d(on)}$	$R_{Gon} = 3$ $\Omega$	$V_{CC} = 1200$ V $I_C = 600$ A		230	ns
$t_r$				90	ns
$E_{on}$				335	mJ
$t_{d(off)}$	$R_{Goff} = 3$ $\Omega$	$T_j = 125$ °C $V_{GE} = \pm 15$ V		1030	ns
$t_f$				160	ns
$E_{off}$				245	mJ
$R_{th(j-c)}$	per IGBT			0,04	K/W



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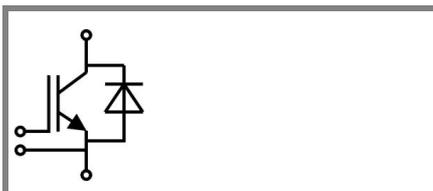
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### Characteristics

Symbol	Conditions	min.	typ.	max.	Units
<b>Inverse Diode</b>					
$V_F = V_{EC}$	$I_{Fnom} = 600$ A; $V_{GE} = 0$ V	$T_j = 25$ °C <sub>chiplev.</sub>	1,6	1,9	V
		$T_j = 125$ °C <sub>chiplev.</sub>	1,6		V
$V_{F0}$			1,1	1,3	V
$r_F$			0,83	1	mΩ
$I_{RRM}$	$I_F = 600$ A		650		A
$Q_{rr}$	$di/dt = 6400$ A/μs		230		μC
$E_{rr}$	$V_{GE} = -15$ V; $V_{CC} = 1200$ V		155		mJ
$R_{th(j-c)D}$	per diode			0,07	K/W
<b>Module</b>					
$L_{CE}$			15	20	nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25$ °C	0,18		mΩ
		$T_{case} = 125$ °C	0,22		mΩ
$R_{th(c-s)}$	per module			0,038	K/W
$M_s$	to heat sink M6		3	5	Nm
$M_t$	to terminals M6 (M4)		2,5 (1,1)	5 (2)	Nm
w				330	g

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

This technical information specifies semiconductor devices but promises no characteristics. No warranty or guarantee expressed or implied is made regarding delivery, performance or suitability.

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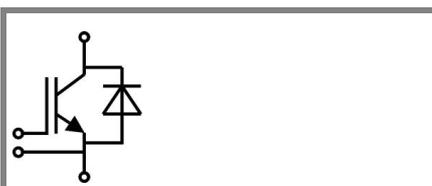
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$Z_{th}$		Values	Units
Symbol	Conditions		
$Z_{th(j-c)I}$			
$R_{\theta j-c}$	$i = 1$	28	mk/W
$R_{\theta j-c}$	$i = 2$	9,5	mk/W
$R_{\theta j-c}$	$i = 3$	2,17	mk/W
$R_{\theta j-c}$	$i = 4$	0,33	mk/W
$\tau_{\theta j-c}$	$i = 1$	0,0447	s
$\tau_{\theta j-c}$	$i = 2$	0,02	s
$\tau_{\theta j-c}$	$i = 3$	0,0015	s
$\tau_{\theta j-c}$	$i = 4$	0,0025	s
$Z_{th(j-c)D}$			
$R_{\theta j-c}$	$i = 1$	46	mk/W
$R_{\theta j-c}$	$i = 2$	17	mk/W
$R_{\theta j-c}$	$i = 3$	5,9	mk/W
$R_{\theta j-c}$	$i = 4$	1,1	mk/W
$\tau_{\theta j-c}$	$i = 1$	0,05	s
$\tau_{\theta j-c}$	$i = 2$	0,0075	s
$\tau_{\theta j-c}$	$i = 3$	0,002	s
$\tau_{\theta j-c}$	$i = 4$	0,0002	s



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